

EAST Search History

| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|-------|------|---|--|------------------|---------|---------------------|
| L1 | 2048 | (313/292,496).CQLS. | US-PGPUB; USPAT | OR | OFF | 2009/05/05 15:03 |
| S51 | 1 | ("6517399").PN. | US-PGPUB; USPAT | OR | OFF | 2009/05/04 16:18 |
| S50 | 27 | ((conductive adj adhesive) with (solder (Low adj melting adj point adj metal))) and spacer and ((electron field) adj (emission emitter)).ti | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2009/05/04 15:28 |
| S49 | 0 | ((conductive adj adhesive) with (solder (Low adj melting adj point adj metal))) and spacer and ((electron field) adj (emission emitter)).ti | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2009/05/04 15:28 |
| S48 | 789 | ((conductive adj adhesive) with (solder (Low adj melting adj point adj metal))) and spacer | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2009/05/04 15:27 |
| S47 | 6653 | ((conductive adj adhesive) with (solder (Low adj melting adj point adj metal))) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2009/05/04 15:27 |
| S46 | 41 | ((conductive adj adhesive) with (Low adj melting adj point adj metal)) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2009/05/04 15:22 |
| S45 | 41 | ((conductive adj adhesive) with (Low adj melting adj point adj metal)) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2009/05/04 15:21 |
| S44 | 0 | ((conductive adj adhesive) with (Low adj melting adj point adj metal)) and ((electron field surface) adj (emission emitter)).ti | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2009/05/04 15:21 |

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|-----|-----|--|--|----|-----|---------------------|
| S43 | 0 | ((conductive adj adhesive) with (Low adj melting adj point adj metal))and ((electron field surface) adj (emission emitter)).ti. | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2009/05/04 15:21 |
| S42 | 5 | (spacer with (conductive adj adhesive)) and ((electron field surface) adj (emission emitter)).ti. | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2009/05/04 15:20 |
| S41 | 15 | (spacer with tin) and ((electron field surface) adj (emission emitter)).ti. | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2009/05/04 15:17 |
| S40 | 5 | (spacer with solder) and ((electron field surface) adj (emission emitter)).ti. | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2009/05/04 15:15 |
| S39 | 1 | ("7078854").PN. | US-PGPUB; USPAT | OR | OFF | 2009/05/04 15:13 |
| S38 | 1 | ("20040075378").PN. | US-PGPUB; USPAT | OR | OFF | 2009/05/04 15:11 |
| S37 | 1 | ("20040075378").PN. | US-PGPUB; USPAT | OR | OFF | 2009/04/21 16:28 |
| S36 | 27 | spacer with (low adj melting adj metal) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2009/04/21 16:24 |
| S35 | 24 | spacer and bonding with (low adj melting adj metal) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2009/04/21 16:14 |
| S34 | 1 | ("6884138").PN. | US-PGPUB; USPAT | OR | OFF | 2009/04/21 16:10 |
| S33 | 1 | ("20070138937").PN. | US-PGPUB; USPAT | OR | OFF | 2009/04/20 17:09 |
| S32 | 15 | (gold adj palladium adj alloy) with (melting adj point) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2009/04/20 15:15 |
| S31 | 155 | (gold adj alloy) with (melting adj point) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2009/04/20 14:20 |
| S30 | 0 | (gold adj alloy) with paladium with (melting adj point) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2009/04/20 14:20 |

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